- Three-State Versions of '151, 'LS151, 'S151
- Three-State Outputs Interface Directly with System Bus
- Perform Parallel-to-Serial Conversion
- Permit Multiplexing from N-lines to One Line
- Complementary Outputs Provide True and Inverted Data
- Fully Compatible with Most TTL Circuits

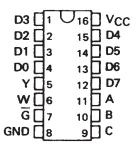
TYPE	MAX NO. OF COMMON OUTPUTS	TYPICAL AVG PROP DELAY TIME (D TO Y)	TYPICAL POWER DISSIPATION
SN54251	49	17 ns	250 mW
SN74251	129	17 ns	250 mW
SN54LS251	49	17 ns	35 mW
SN74LS251	129	17 ns	35 mW
SN54S251	39	8 ns	275 mW
SN74S251	129	8 ns	275 mW

description

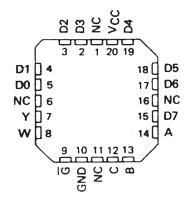
These monolithic data selectors/multiplexers contain full on-chip binary decoding to select one-of-eight data sources and feature a strobe-controlled three-state output. The strobe must be at a low logic level to enable these devices. The three-state outputs permit a number of outputs to be connected to a common bus. When the strobe input is high, both outputs are in a high-impedance state in which both the upper and lower transistors of each totem-pole output are off, and the output neither drives nor loads the bus significantly. When the strobe is low, the outputs are activated and operate as standard TTL totem-pole outputs.

To minimize the possibility that two outputs will attempt to take a common bus to opposite logic levels, the output control circuitry is designed so that the 'average output disable time is shorter than the average output enable time. The SN54251 and SN74251 have output clamp diodes to attenuate reflections on the bus line.

SN54251, SN54LS251, SN54S251 . . . J OR W PACKAGE SN74251 . . . N PACKAGE SN74LS251, SN74S251 . . . D OR N PACKAGE (TOP VIEW)



SN54LS251, SN54S251 . . . FK PACKAGE (TOP VIEW)



NC - No internal connection

FUNCTION TABLE

	11	VPUT	S	OUT	PUTS
S	ELEC	T	ENABLE	v	w
С	В	Α	G		**
X	Х	×	н	z	Z
L	L	L	L	D0	DO
L	L	н	L	D1	DI
L	н	Ł	L	D2	D2
L	н	Н	L	D3	D3
н	L	L	L	D4	D4
н	L	н	L	D5	D5
н	н	L	L	D6	D6
н	н	н	L	D7	D7

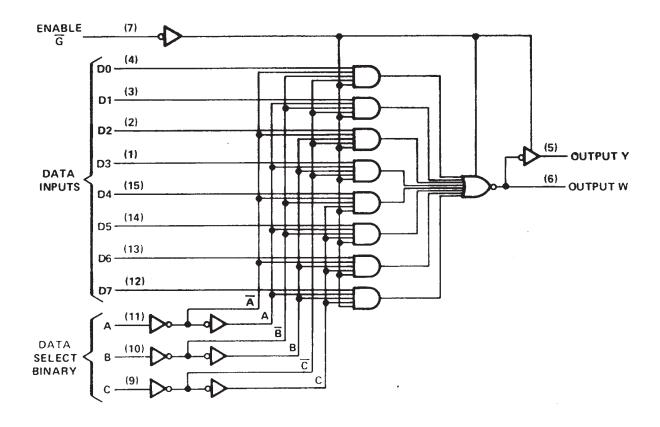
H = high logic level, L = low logic level

X = irrelevant, Z = high impedance (off)

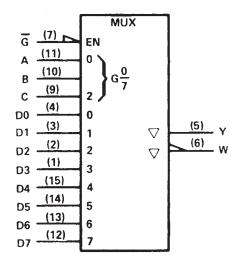
D0, D1 . . . D7 = the level of the respective D input

SDLS085 - DECEMBER 1972 - REVISED MARCH 1988

logic diagram (positive logic)



logic symbol†



 $^{^{\}dagger}$ This symbol is in accordance with ANSI/IEEE Std. 91-1984 and IEC Publication 617-12. Pin numbers shown are for D, J, N, and W packages.



SN54251 SN74251, DATA SELECTORS/MULTIPLEXERS WITH 3-STATE OUTPUTS

SDLS085 - DECEMBER 1972 - REVISED MARCH 1988

absolute maximum ratings over operating free-air temperature range (unless otherwise noted)

Supply voltage, V _{CC} (see Note 1)				 							7 V
Input voltage				 							5.5 V
Off-state output voltage				 				•			5.5 V
Operating free-air temperature range	: SN54251		 	 					–55°	°C to	125°C
	SN74251										
Storage temperature range				 					-65°	'C to	150°C

NOTE 1: Voltage values are with respect to network ground terminal.

recommended operating conditions

		SN5425	1		SN7425	1	UNIT
	MIN	NOM	MAX	MIN	NOM	MAX	DIVIT
Supply voltage, V _{CC}	4.5	5	5.5	4.75	5	5.25	٧
High-level output current, IOH			-2			-5.2	mA
Low-level output current, IOL			16			16	mA
Operating free-air temperature, TA	-55		125	0		70	°C

electrical characteristics over recommended operating free-air temperature range (unless otherwise noted)

	PARAMETER	TEST COND	ITIONS [†]	MIN	TYP‡	MAX	UNIT
VIH	High-level input voltage			2	-		V
VIL	Low-level input voltage					0.8	V
VIK	Input clamp voltage	V _{CC} = MIN, I _I	= -12 mA			-1.5	V
Vон	High-level output voltage	**	H = 2 V, H = MAX	2.4	3.2		٧
VOL	Low-level output voltage	, ,	H = 2 V, L = 16 mA		0.2	0.4	٧
loz	Off-state (high-impedance-state) output current	V _{CC} = MAX, V _{IH} = 2 V	V _O = 2.4 V V _O = 0.4 V			40 -40	μА
v _o	Output clamp voltage	V _{CC} = MAX, V _{IH} = 4.5 V	I _O = -12 mA		V	-1.5 CC+1.5	٧
Ťį	Input current at maximum input voltage	V _{CC} = MAX, V _I	= 5.5 V			1	mA
ħН	High-level input current	V _{CC} = MAX, V _I	= 2.4 V			40	μА
HL	Low-level input current	V _{CC} = MAX, V _I	= 0.4 V			-1.6	mA
los	Short-circuit output current §	V _{CC} = MAX		-18		-55	mA
Icc	Supply current	V _{CC} = MAX, All All outputs open	l inputs at 4.5 V,		38	62	mA

[†] For conditions shown as MIN or MAX, use the appropriate value specified under recommended operating conditions for the applicable type.

[‡] All typical values are at $V_{CC} = 5 \text{ V}$, $T_A = 25^{\circ} \text{C}$.

Not more than one output should be shorted at a time.

switching characteristics, VCC = 5 V, TA = 25°C

PARAMETER†	FROM (INPUT)	TO (OUTPUT)	TEST CONDITIONS	MIN TYP	MAX	UNIT
^t PLH	A, B, or C	· Y		29	45	ns
tPHL	(4 levels)	'	j	28	45	1115
TPLH	A, B, or C	w	1	20	33	ns
tPHL .	(3 levels)			21	33] "
ФLH	Any D	Y	Cլ = 50 pF,	17	28	ns
PHL	ם עוויס	'	$R_L = 400 \Omega$,	18	28] "
^t PLH	Any D	w	See Note 2	10	15	ns
ФНL	Ally D		Sec ivote 2	9	15	l '''.
[†] PZH	G .	Y		17	27	I
^t PZL		1		26	40	ns
^t PZH	G	W		17	27	ns
[†] PZL		"		24	40] '''
tPHZ	Ğ	Y	Cլ = 5 pF,	5	8	ns
^t PLZ		w	$R_L = 400 \Omega$,	15	23	<u> </u>
^t PHZ	G		See Note 2	5	8	ns
tPLZ	1	**	See 140(e 2	15	23] '''

 $^{^{\}dagger}t_{PLH}$ = Propagation delay time, low-to-high-level output

tpZH = Output enable time to high level

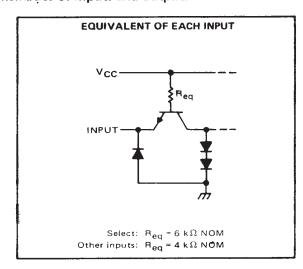
tpZL = Output enable time to low level

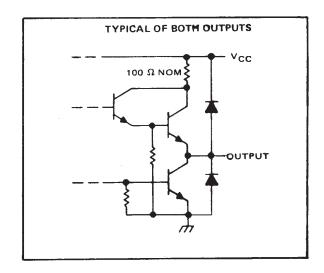
tpHZ = Output disable time from high level

tPLZ = Output disable time from low level

NOTE 2: Load circuits and voltage waveforms are shown in Section 1.

schematics of inputs and outputs





tpHL = Propagation delay time, high-to-low-level output

SN54LS251 SN74LS251, DATA SELECTORS/MULTIPLEXERS WITH 3-STATE OUTPUTS

SDLS085 - DECEMBER 1972 - REVISED MARCH 1988

absolute maximum ratings over operating free-air temperature range (unless otherwise noted)

Supply voltage, V _{CC} (see Note 1)		 												, 7 V	•
Input voltage		 								.•				. 7 V	1
Off-state output voltage		 												. 5.5 V	1
Operating free-air temperature range	: SN54LS251										5	5°	C to	o 125°C	,
	SN74LS251														
Storage temperature range						 	 _	_			-6	5°	C to	o 150°C	;

NOTE 1: Voltage values are with respect to network ground terminal.

recommended operating conditions

		s	4.5 5	:51	S	N74LS2	251	LINIT
		MIN	NOM	MAX	MIN	NOM	MAX	UNIT
Vcc	Supply voltage	4.5	5	5.5	4.75	5	5.25	V
VIH	High-level input voltage	2			2			V
VIL	Low-level input voltage			0.7			0.8	V
Тон	High-level output current			- 1			- 2.6	mA
IOL	Low-level output current			4			8	mA
TA	Operating free-air temperature	- 55		125	0		70	°C

electrical characteristics over recommended operating free-air temperature range (unless otherwise noted)

DADAMETED		TEST COM	DITIONST		S	N54LS2	51	SI	N74LS2	51	UNIT
PARAMETER		TEST CON	DITIONS		MIN	TYP ‡	MAX	MIN	TYP\$	MAX	UNIT
V _{IK}	V _{CC} = MIN,	I _I = - 18 mA					- 1.5			- 1.5	V
V _{OH}	V _{CC} = MIN, I _{OH} = MAX	V _{IH} = 2 V,	VIL = MAX		2.4	3.4		2.4	3.1		٧
\/	VCC = MIN,	V _{1H} = 2 V,		IOL = 4 mA		0.25	0.4		. 0.25	0.4	V
VOL	VIL = MAX			10L = 8 mA					0.35	0.5	ľ
1	V _{CC} = MAX,	= 2.V		V _O = 2.7 V			- 20			20	μА
loz	VCC - MAA,	VIH - 2 V		V _O = 0.4 V			20			- 20	μΑ.
11	V _{CC} = MAX,	V ₁ = 7 V					0.1			0.1	mA
Чн	V _{CC} = MAX,	V ₁ = 2.7 V					20			20	μА
Enable G	V _{CC} = MAX,	V. = 0.4					- 0.2			0.2	mA
All other	VCC - MAA,	V 1 - 0.4					- 0.4			- 0.4	1112
los§	V _{CC} = MAX				- 30		- 130	- 30		- 130	mA
				Condition A		6.1	10		6.1	10	mA
'cc	V _{CC} = MAX,	See Note 3		Condition B		7.1	12		7.1	12	IIIA

[†] For conditions shown as MIN or MAX, use the appropriate value specified under recommended operating conditions for the applicable type.

- A. Enable grounded.
- B. Strobe at 4.5 V.



[‡] All typical values are at V_{CC} = 5 V, T_A = 25°C.

[§] Not more than one output should be shorted at a time, and duration of the short-circuit should not exceed one second.

NOTE 3: I_{CC} is measured with the outputs open and all data and select inputs at 4.5 V under the following conditions:

SN54LS251 SN74LS251, (TIM9905), DATA SELECTORS/MULTIPLEXERS WITH 3-STATE OUTPUTS

SDLS085 - DECEMBER 1972 - REVISED MARCH 1988

switching characteristics, VCC = 5 V, TA = 25°C

PARAMETER†	FROM (INPUT)	TO (OUTPUT)	TEST CONDITIONS	MIN	TYP	MAX	UNIT
tPLH .	A, B, or C	Y			29	45	
^t PHL	(4 levels)	'			28	45	ns
tPLH .	A, B, or C	w			20 .	33	ns
^t PHL	(3 levels)	"			. 21	33	l lis
ФLH	Any D	Y]		17	28	กร
ФНL	Ally b	<u>'</u>	$C_L = 15 pF$,		18	28	113
^t PLH	Any D	w	$R_L = 2 k\Omega$,		10	15	กร
^t PHL		**	See Note 2		9	15	'''
^t PZH	G	Y	7		30	45	ns
^t PZL		· ·			26	40	113
^t PZH	G	w	7		17	27	ns
^t PZL		"			24	40	'''
^t PHZ	Ğ	Y W	C: - E = E		30	45	ns
tPLZ	G		C _L = 5 pF,		15	25	113
^t PHZ	Ğ		$R_{L} = 2 k\Omega,$ See Note 2		37	55	ns
tPLZ			See Note 2		15	25	

†tpLH = Propagation delay time, low-to-high-level output

tpHL = Propagation delay time, high-to-low-level output

tpZH = Output enable time to high level

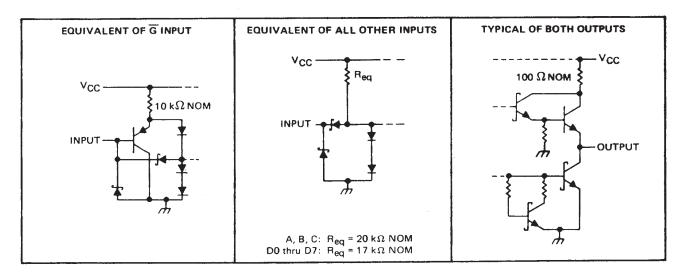
 t_{PZL} = Output enable time to low level

 t_{PHZ} = Output disable time from high level

tpLZ = Output disable time from low level

NOTE 2: Load circuits and voltage waveforms are shown in Section 1.

schematics of inputs and outputs



SN54S251 SN74S251, DATA SELECTORS/MULTIPLEXERS WITH 3-STATE OUTPUTS

SDLS085 - DECEMBER 1972 - REVISED MARCH 1988

absolute maximum ratings over operating free-air temperature range (unless otherwise noted)

Supply voltage, VCC (see Note 1)		 					 						7 V
Input voltage		 					 						5.5 V
Off-state output voltage													5.5 V
Operating free-air temperature range: SN54S25	1	 					 			-5	5°C	to	125°C
SN74S25	1	 					 				0°	C t	o 70°C
Storage temperature range							 			-6	5°C	to	150°C

NOTE 1: Voltage values are with respect to network ground terminal.

recommended operating conditions

	S	N54S25	1	5	N74S2	51 ₋	
	MIN	NOM	MAX	MIN	NOM	MAX	UNIT
Supply voltage, V _{CC}	4.5	5	- 5.5	4.75	5	5.25	V
High-level output current, IOH			-2			-6.5	mA
Low-level output current, IOL		· · · · · · · · · · · · · · · · · · ·	20			20	mA
Operating free-air temperature, TA	-55		125	0		70	°c

electrical characteristics over recommended operating free-air temperature range (unless otherwise noted)

	PARAMETER	TEST CONDITIONS†					TYP‡	MAX	UNIT
VIH	High-level input voltage					2			V
VIL	Low-level input voltage							0.8	V
VIK	Input clamp voltage	V _{CC} = MIN,	11:	= -18 mA				-1.2	V
VOH	High-level output voltage	V _{CC} = MIN,	V _{IH} = 2 V, I _{OH} = MAX		SN545'	2.4	3.4		V
		V _{IL} = 0.8 V,			SN745'	2.4	3.2		٧
VOL	Low-level output voltage	V _{CC} = MIN,	/ _{CC} = MIN, V _{IH} = 2 V,			1		0.5	V
		V _{1L} = 0.8 V,	101	_ = 20 mA		1		0.5	"
•	Off-state (high-impedance-state) output current	V _{CC} = MAX,	= MAX, V _O = 2.4 V					50	μА
loz		V _{IH} = 2 V		V _O = 0.5 V				-50	μΑ
l _j	Input current at maximum input voltage	V _{CC} = MAX,	VI	= 5.5 V				1	mA
ЧН	High-level input current	VCC = MAX,	Vı	= 2.7 V				50	μА
I _I L	Low-level input current	V _{CC} = MAX,	VI	= 0.5 V				-2	mA .
los	Short-circuit output current §	V _{CC} = MAX				-40		-100	mA
	0 1	V _{CC} = MAX, All inputs at 4.5 V,					55	85	mA
1CC	Supply current	All outputs open					33	05	. IIIA

[†] For conditions shown as MIN or MAX, use the appropriate value specified under recommended operating conditions for the applicable type. ‡ AII typical values are at $^{\lor}$ CC = 5 $^{\lor}$ C.



[§] Not more than one output should be shorted at a time, and duration of the short-circuit should not exceed one second.

switching characteristics, VCC = 5 V, TA = 25°C

PARAMETER [†]	FROM (INPUT)	TO (OUTPUT)	TEST CONDITIONS	MIN TY	MAX	UNIT
tPLH	A, B, or C	Y		12	18	ns
tPHL	(4 levels)	'		13	19.5	
^t PLH	A, B, or C	w	Cլ = 15 pF,	10	15	ns
tphl.	(3 levels)	**	RL = 280 Ω,	9	13.5	
[†] PLH	Any D	Y	See Note 2	8	12	ns
[‡] PHL	7 71190	'		8	12] "
^t PLH	Any D	w		4.5	7	ns
^t PHL	7 ^""			4.5	7	
^t PZH	G	Y	C _L = 50 pF,	13	19.5	ns
^t PZL	7 "		R _L = 280 Ω,	14	21	<u> </u>
^t PZH	G	w	See Note 2	13	19.5	ns
[†] PZL	-	**	See Note 2	14	21	""
[†] PHZ	G	Y	C _L = 5 pF,	5.5	8.5	ns
tPLZ	٦ ،	1	$R_L = 280 \Omega$,	(14] '''
[†] PHZ	G	w	See Note 2	5.5	8.5	ns
†PLZ	7	•••	366 140te 2	9	14	

[†]tpLH = Propagation delay time, low-to-high-level output

tpHL = Propagation delay time, high-to-low-level output

t_{PZH} = Output enable time to high level

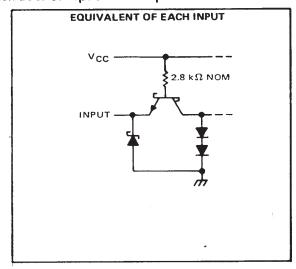
 t_{PZL} = Output enable time to low level

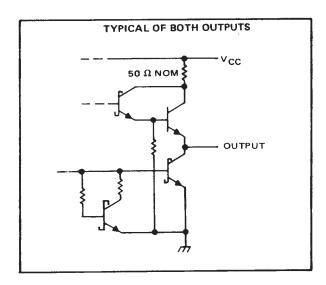
tpHZ = Output disable time from high level

 t_{PLZ} = Output disable time from low level

NOTE 2: Load circuits and voltage waveforms are shown in Section 1.

schematics of inputs and outputs









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PACKAGING INFORMATION

Orderable Device	Status ⁽¹⁾	Package Type	Package Drawing	Pins	Package Qty	Eco Plan ⁽²⁾	Lead/Ball Finish	MSL Peak Temp ⁽³⁾
7601601EA	ACTIVE	CDIP	J	16	1	TBD	Call TI	Level-NC-NC-NC
7601601FA	ACTIVE	CFP	W	16	1	TBD	Call TI	Level-NC-NC-NC
7601601FA	ACTIVE	CFP	W	16	1	TBD	Call TI	Level-NC-NC-NC
80022012A	OBSOLETE	LCCC	FK	20		TBD	Call TI	Call TI
80022012A	OBSOLETE	LCCC	FK	20		TBD	Call TI	Call TI
8002201EA	OBSOLETE	CDIP	J	16		TBD	Call TI	Call TI
8002201EA	OBSOLETE	CDIP	J	16		TBD	Call TI	Call TI
8002201FA	OBSOLETE	CFP	W	16		TBD	Call TI	Call TI
8002201FA	OBSOLETE	CFP	W	16		TBD	Call TI	Call TI
JM38510/07905BEA	OBSOLETE	CDIP	J	16		TBD	Call TI	Call TI
JM38510/07905BEA	OBSOLETE	CDIP	J	16		TBD	Call TI	Call TI
JM38510/30905B2A	ACTIVE	LCCC	FK	20	1	TBD	Call TI	Level-NC-NC-NC
JM38510/30905B2A	ACTIVE	LCCC	FK	20	1	TBD	Call TI	Level-NC-NC-NC
JM38510/30905BEA	ACTIVE	CDIP	J	16	1	TBD	Call TI	Level-NC-NC-NC
JM38510/30905BEA	ACTIVE	CDIP	J	16	1	TBD	Call TI	Level-NC-NC-NC
JM38510/30905BFA	ACTIVE	CFP	W	16	1	TBD	Call TI	Level-NC-NC-NC
JM38510/30905BFA	ACTIVE	CFP	W	16	1	TBD	Call TI	Level-NC-NC-NC
SN54251J	OBSOLETE	CDIP	J	16		TBD	Call TI	Call TI
SN54251J	OBSOLETE	CDIP	J	16		TBD	Call TI	Call TI
SN54LS251J	ACTIVE	CDIP	J	16	1	TBD	Call TI	Level-NC-NC-NC
SN54LS251J	ACTIVE	CDIP	J	16	1	TBD	Call TI	Level-NC-NC-NC
SN54S251J	OBSOLETE	CDIP	J	16		TBD	Call TI	Call TI
SN54S251J	OBSOLETE	CDIP	J	16		TBD	Call TI	Call TI
SN74251N	OBSOLETE	PDIP	N	16		TBD	Call TI	Call TI
SN74251N	OBSOLETE	PDIP	N	16		TBD	Call TI	Call TI
SN74251N3	OBSOLETE	PDIP	N	16		TBD	Call TI	Call TI
SN74251N3	OBSOLETE	PDIP	N	16		TBD	Call TI	Call TI
SN74LS251D	ACTIVE	SOIC	D	16	40	Pb-Free (RoHS)	CU NIPDAU	Level-2-260C-1 YEAR Level-1-235C-UNLIM
SN74LS251D	ACTIVE	SOIC	D	16	40	Pb-Free (RoHS)	CU NIPDAU	Level-2-260C-1 YEAR Level-1-235C-UNLIM
SN74LS251DE4	ACTIVE	SOIC	D	16	40	Pb-Free (RoHS)		Level-2-260C-1 YEAR Level-1-235C-UNLIM
SN74LS251DE4	ACTIVE	SOIC	D	16	40	Pb-Free (RoHS)	CU NIPDAU	Level-2-260C-1 YEAR Level-1-235C-UNLIM
SN74LS251DR	ACTIVE	SOIC	D	16	2500	Pb-Free (RoHS)	CU NIPDAU	Level-2-260C-1 YEAR Level-1-235C-UNLIM
SN74LS251DR	ACTIVE	SOIC	D	16	2500	Pb-Free (RoHS)	CU NIPDAU	Level-2-260C-1 YEAR Level-1-235C-UNLIM
SN74LS251DRE4	ACTIVE	SOIC	D	16	2500	Pb-Free (RoHS)	CU NIPDAU	Level-2-260C-1 YEAR Level-1-235C-UNLIM
SN74LS251DRE4	ACTIVE	SOIC	D	16	2500	Pb-Free (RoHS)	CU NIPDAU	Level-2-260C-1 YEAR Level-1-235C-UNLIM
SN74LS251N	ACTIVE	PDIP	N	16	25	Pb-Free (RoHS)	CU NIPDAU	Level-NC-NC-NC





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Orderable Device	Status ⁽¹⁾	Package Type	Package Drawing	Pins	Package Qty	Eco Plan (2)	Lead/Ball Finish	n MSL Peak Temp ⁽³⁾
SN74LS251N	ACTIVE	PDIP	N	16	25	Pb-Free (RoHS)	CU NIPDAU	Level-NC-NC-NC
SN74LS251N3	OBSOLETE	PDIP	N	16		TBD	Call TI	Call TI
SN74LS251N3	OBSOLETE	PDIP	N	16		TBD	Call TI	Call TI
SN74LS251NE4	ACTIVE	PDIP	N	16	25	Pb-Free (RoHS)	CU NIPDAU	Level-NC-NC-NC
SN74LS251NE4	ACTIVE	PDIP	N	16	25	Pb-Free (RoHS)	CU NIPDAU	Level-NC-NC-NC
SN74LS251NSR	ACTIVE	SO	NS	16	2000	Pb-Free (RoHS)	CU NIPDAU	Level-2-260C-1 YEAR/ Level-1-235C-UNLIM
SN74LS251NSR	ACTIVE	SO	NS	16	2000	Pb-Free (RoHS)	CU NIPDAU	Level-2-260C-1 YEAR/ Level-1-235C-UNLIM
SN74LS251NSRE4	ACTIVE	SO	NS	16	2000	Pb-Free (RoHS)	CU NIPDAU	Level-2-260C-1 YEAR/ Level-1-235C-UNLIM
SN74LS251NSRE4	ACTIVE	SO	NS	16	2000	Pb-Free (RoHS)	CU NIPDAU	Level-2-260C-1 YEAR/ Level-1-235C-UNLIM
SN74S251D	OBSOLETE	SOIC	D	16		TBD	Call TI	Call TI
SN74S251D	OBSOLETE	SOIC	D	16		TBD	Call TI	Call TI
SN74S251N	OBSOLETE	PDIP	N	16		TBD	Call TI	Call TI
SN74S251N	OBSOLETE	PDIP	N	16		TBD	Call TI	Call TI
SN74S251N3	OBSOLETE	PDIP	N	16		TBD	Call TI	Call TI
SN74S251N3	OBSOLETE	PDIP	N	16		TBD	Call TI	Call TI
SNJ54251J	OBSOLETE	CDIP	J	16		TBD	Call TI	Call TI
SNJ54251J	OBSOLETE	CDIP	J	16		TBD	Call TI	Call TI
SNJ54LS251FK	ACTIVE	LCCC	FK	20	1	TBD	Call TI	Level-NC-NC-NC
SNJ54LS251FK	ACTIVE	LCCC	FK	20	1	TBD	Call TI	Level-NC-NC-NC
SNJ54LS251J	ACTIVE	CDIP	J	16	1	TBD	Call TI	Level-NC-NC-NC
SNJ54LS251J	ACTIVE	CDIP	J	16	1	TBD	Call TI	Level-NC-NC-NC
SNJ54LS251W	ACTIVE	CFP	W	16	1	TBD	Call TI	Level-NC-NC-NC
SNJ54LS251W	ACTIVE	CFP	W	16	1	TBD	Call TI	Level-NC-NC-NC
SNJ54S251FK	OBSOLETE	LCCC	FK	20		TBD	Call TI	Call TI
SNJ54S251FK	OBSOLETE	LCCC	FK	20		TBD	Call TI	Call TI
SNJ54S251J	OBSOLETE	CDIP	J	16		TBD	Call TI	Call TI
SNJ54S251J	OBSOLETE	CDIP	J	16		TBD	Call TI	Call TI
SNJ54S251W	OBSOLETE	CFP	W	16		TBD	Call TI	Call TI
SNJ54S251W	OBSOLETE	CFP	W	16		TBD	Call TI	Call TI

 $^{^{(1)}}$ The marketing status values are defined as follows:

ACTIVE: Product device recommended for new designs.

LIFEBUY: TI has announced that the device will be discontinued, and a lifetime-buy period is in effect.

NRND: Not recommended for new designs. Device is in production to support existing customers, but TI does not recommend using this part in a new design.

PREVIEW: Device has been announced but is not in production. Samples may or may not be available.

OBSOLETE: TI has discontinued the production of the device.

TBD: The Pb-Free/Green conversion plan has not been defined.

Pb-Free (RoHS): TI's terms "Lead-Free" or "Pb-Free" mean semiconductor products that are compatible with the current RoHS requirements

⁽²⁾ Eco Plan - The planned eco-friendly classification: Pb-Free (RoHS) or Green (RoHS & no Sb/Br) - please check http://www.ti.com/productcontent for the latest availability information and additional product content details.



PACKAGE OPTION ADDENDUM

6-Jun-2005

for all 6 substances, including the requirement that lead not exceed 0.1% by weight in homogeneous materials. Where designed to be soldered at high temperatures, TI Pb-Free products are suitable for use in specified lead-free processes.

Green (RoHS & no Sb/Br): TI defines "Green" to mean Pb-Free (RoHS compatible), and free of Bromine (Br) and Antimony (Sb) based flame retardants (Br or Sb do not exceed 0.1% by weight in homogeneous material)

(3) MSL, Peak Temp. -- The Moisture Sensitivity Level rating according to the JEDEC industry standard classifications, and peak solder temperature.

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14 LEADS SHOWN



- A. All linear dimensions are in inches (millimeters).
- B. This drawing is subject to change without notice.
- C. This package is hermetically sealed with a ceramic lid using glass frit.
- D. Index point is provided on cap for terminal identification only on press ceramic glass frit seal only.
- E. Falls within MIL STD 1835 GDIP1-T14, GDIP1-T16, GDIP1-T18 and GDIP1-T20.

W (R-GDFP-F16)

CERAMIC DUAL FLATPACK



- A. All linear dimensions are in inches (millimeters).
- B. This drawing is subject to change without notice.
- C. This package can be hermetically sealed with a ceramic lid using glass frit.
- D. Index point is provided on cap for terminal identification only.
- E. Falls within MIL STD 1835 GDFP1-F16 and JEDEC MO-092AC



FK (S-CQCC-N**)

28 TERMINAL SHOWN

LEADLESS CERAMIC CHIP CARRIER



NOTES: A. All linear dimensions are in inches (millimeters).

- B. This drawing is subject to change without notice.
- C. This package can be hermetically sealed with a metal lid.
- D. The terminals are gold plated.
- E. Falls within JEDEC MS-004



N (R-PDIP-T**)

PLASTIC DUAL-IN-LINE PACKAGE

16 PINS SHOWN

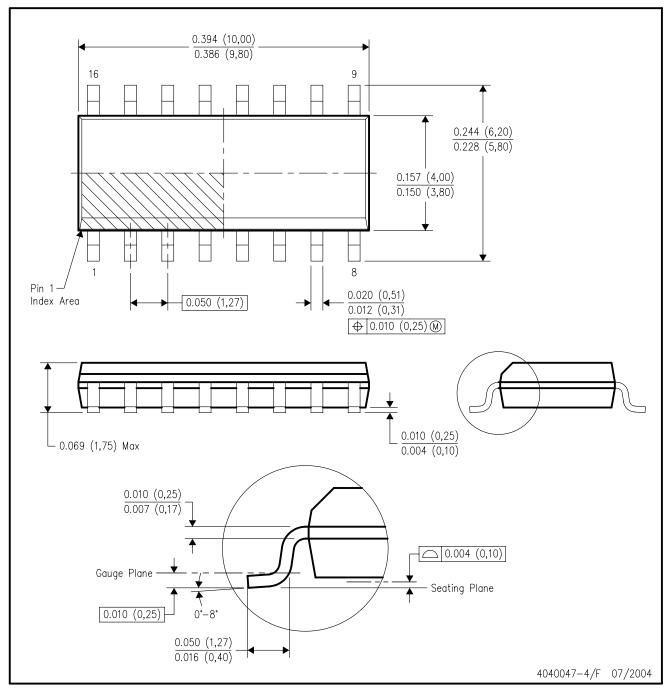


- A. All linear dimensions are in inches (millimeters).
- B. This drawing is subject to change without notice.
- Falls within JEDEC MS-001, except 18 and 20 pin minimum body length (Dim A).
- The 20 pin end lead shoulder width is a vendor option, either half or full width.



D (R-PDSO-G16)

PLASTIC SMALL-OUTLINE PACKAGE



- A. All linear dimensions are in inches (millimeters).
- B. This drawing is subject to change without notice.
- C. Body dimensions do not include mold flash or protrusion not to exceed 0.006 (0,15).
- D. Falls within JEDEC MS-012 variation AC.



MECHANICAL DATA

NS (R-PDSO-G**)

14-PINS SHOWN

PLASTIC SMALL-OUTLINE PACKAGE



- A. All linear dimensions are in millimeters.
- B. This drawing is subject to change without notice.
- C. Body dimensions do not include mold flash or protrusion, not to exceed 0,15.



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